

Typical Applications

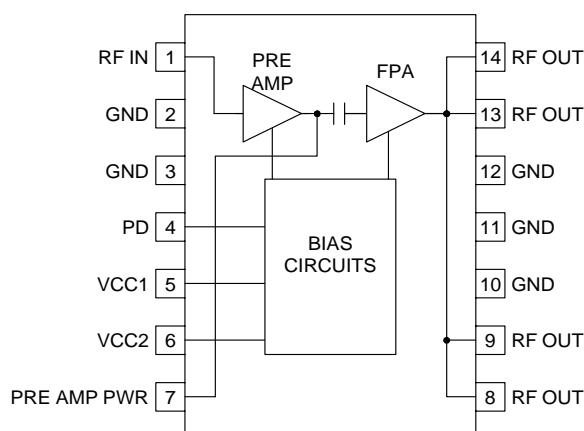
- Digital Communication Systems
- Spread-Spectrum Communication Systems
- Driver for Higher Power Linear Applications
- Portable Battery-Powered Equipment
- Commercial and Consumer Systems
- Base Station Equipment

Product Description

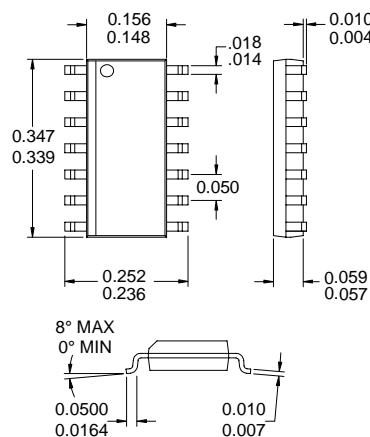
The RF2103P is a medium power linear amplifier IC. The device is manufactured on an advanced Gallium Arsenide Heterojunction Bipolar Transistor (HBT) process, and has been designed for use as the final linear RF amplifier in UHF radio transmitters operating between 450MHz and 1000MHz. It may also be used as a driver amplifier in higher power applications. The device is self-contained with the exception of the output matching network, power supply feed line, and bypass capacitors, and it produces an output power level of 750mW (CW). The device can be used in 3 cell battery applications. The maximum CW output at 3.6V is 175mW. The unit has a total gain of 31dB, depending upon the output matching network.

Optimum Technology Matching® Applied

- | | | |
|-------------------------------------|--|--------------------------------------|
| <input type="checkbox"/> Si BJT | <input checked="" type="checkbox"/> GaAs HBT | <input type="checkbox"/> GaAs MESFET |
| <input type="checkbox"/> Si Bi-CMOS | <input type="checkbox"/> SiGe HBT | <input type="checkbox"/> Si CMOS |



Functional Block Diagram



Package Style: SOIC-14

Features

- 450MHz to 1000MHz Operation
- Up to 750mW CW Output Power
- 31dB Small Signal Gain
- Single 2.7V to 7.5V Supply
- 47% Efficiency
- Digitally Controlled Power Down Mode

Ordering Information

RF2103P Medium Power Linear Amplifier
RF2103P PCBA Fully Assembled Evaluation Board

RF Micro Devices, Inc.
7628 Thorndike Road
Greensboro, NC 27409, USA

Tel (336) 664 1233
Fax (336) 664 0454
<http://www.rfmd.com>

Absolute Maximum Ratings

Parameter	Rating	Unit
Supply Voltage	-0.5 to +7.5	V _{DC}
Power Down Voltage (V _{PD})	-0.5 to +5	V
DC Supply Current	350	mA
Input RF Power	+12	dBm
Output Load VSWR	10:1	
Operating Case Temperature	-40 to +100	°C
Operating Ambient Temperature	-40 to +85	°C
Storage Temperature	-40 to +150	°C

**Caution!** ESD sensitive device.

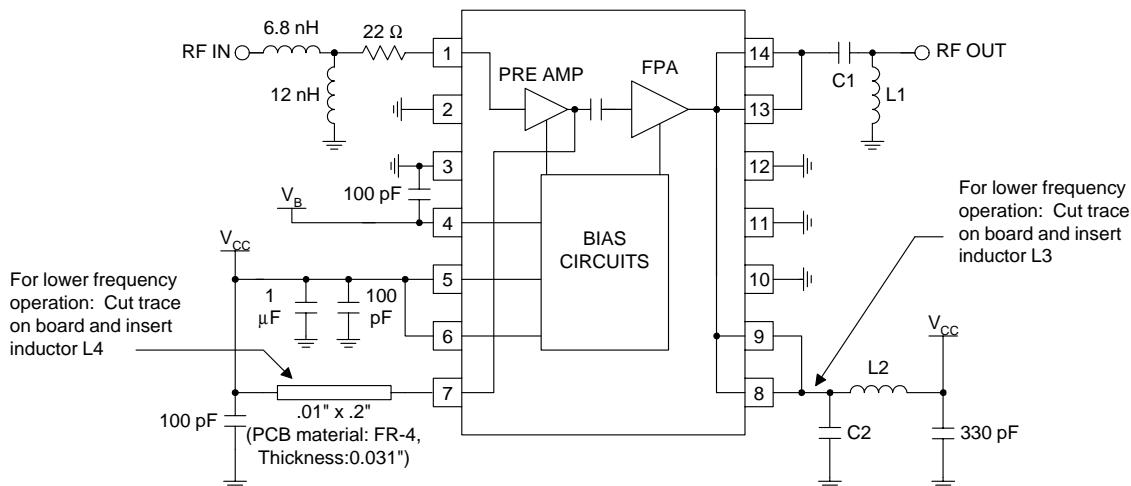
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Parameter	Specification			Unit	Condition
	Min.	Typ.	Max.		
Overall					T=25 °C, V _{CC} =5.8V, V _{PD} =5.0V, Z _{LOAD} =18Ω, P _{IN} =0dBm, Freq=915MHz
Frequency Range	450 to 1000			MHz	V _{CC} =7.5V
Maximum Output Power	+28.8			dBm	V _{CC} =5.8V
Maximum Output Power	+26.5			dBm	Without external second harmonic trap
Second Harmonic	-24			dBc	
Third Harmonic	-30			dBc	
Output Noise Power	<-125			dBm/Hz	With external matching network; see application schematic
Input Impedance	50			Ω	With external matching network; see application schematic
Input VSWR	<2:1				Load Impedance for Optimal Match
Output Impedance	18+j0			Ω	
Nominal 5.8V Configuration					V _{CC} =5.8V, V _{PD} =4.0V, Z _{LOAD} =18Ω, P _{IN} =0dBm, Freq=830MHz
Linear Power Gain	31			dB	
Saturated CW Output Power	24	+26.5		dBm	P _{OUT} =+18.5dBm/tone
IM ₃	-40		-25	dBc	P _{OUT} =+18.5dBm/tone
IM ₅	-45		-30	dBc	Total of pins 7 and 8
Collector Current, I _{CC}	175		250	mA	Into pin 4
V _{PD} Current	<3.5			mA	
CW Total Efficiency	47			%	P _{OUT} =+18.5dBm/tone
Two Tone Total Efficiency	26			%	
Power Supply					
Power Supply Voltage	2.7 to 7.5			V	
Power Supply Idle Current	45	80		mA	
Total "OFF" Current Drain	1	10		μA	V _{PD} <0.1V _{DC}
Turn-on Time	<100			ns	V _{PD} =0 to V _{PD} =+4V _{DC}

Pin	Function	Description	Interface Schematic
1	RF IN	RF input pin. There is an internal blocking capacitor between this pin and the preamp input, but not between the pin and an internal $2\text{k}\Omega$ resistor to ground.	
2	GND	Ground connection. For best performance, keep traces physically short and connect immediately to ground plane.	
3	GND	Same as pin 2.	
4	PD	Power down control voltage. When this pin is at 0V, the device will be in power down mode, dissipating minimum DC power. When this pin is at V_{CC} (3V to 6.5V), the device will be in full power mode delivering maximum available gain and output power capability. This pin may also be used to perform some degree of gain control or power control when set to voltages between 0V and V_{CC} . It is not optimized for this function so the transfer function is not linear over a wide range as with other devices specifically designed for analog gain control; however, it may be usable for coarse adjustment or in some closed loop AGC systems. This pin should not, in any circumstance, be higher in voltage than V_{CC} . This pin should also have an external bypassing capacitor.	
5	VCC1	Positive supply for the active bias circuits. This pin can be externally combined with pin 6 (VCC2) and the pair bypassed with a single capacitor, placed as close as possible to the package. Additional bypassing of $1\mu\text{F}$ is also recommended, but proximity to the package is not as critical. In most applications, pins 5, 6, and 7 can share a single $1\mu\text{F}$ bypass capacitor.	
6	VCC2	Same as pin 5.	
7	PREAMP PWR	Positive supply for the pre-amplifier. This is an unmatched transistor collector output. This pin should see an inductive path to AC ground (V_{CC} with bypass capacitor). This inductance can be achieved with a short, thin microstrip line or with a low value chip inductor (approximately 1.8nH). At lower frequencies, the inductance value should be larger (longer microstrip line) and V_{CC} should be bypassed with a larger bypass capacitor. This inductance forms a matching network with the internal series capacitor between the two amplifier stages, setting the amplifier's frequency of maximum gain. An additional $1\mu\text{F}$ bypass capacitor in parallel with the 100pF bypass capacitor is also recommended, but placement of this component is not as critical. In most applications, pins 5, 6, and 7 can share a single $1\mu\text{F}$ bypass capacitor.	
8	RF OUT	Same as pin 14.	
9	RF OUT	Same as pin 14.	
10	GND	Same as pin 2.	
11	GND	Same as pin 2.	
12	GND	Same as pin 2.	
13	RF OUT	Same as pin 14.	

Pin	Function	Description	Interface Schematic
14	RF OUT	Amplifier RF output. This is an unmatched collector output of the final amplifier transistor. It is internally connected to pins 8, 9, 13 and 14 to provide low series inductance and flexibility in output matching. Bias for the final power amplifier output transistor must also be provided through two of these four pins. Typically, pins 8 and 9 are connected to a network that provides the DC bias and also creates a second harmonic trap. For 915 MHz operation, this harmonic trap network is simply a single 2 pF capacitor from both pins to ground. This capacitor series resonates with internal bond wires at two times the operating frequency, effectively shorting out the second harmonic. Shorting out this harmonic serves to increase the amplifier's maximum output power and efficiency, as well as to lower the level of the second harmonic output. Typically, pins 13 and 14 are externally connected very close to the package and used as the RF output with a matching network that presents the optimum load impedance to the PA for maximum power and efficiency, as well as providing DC blocking at the output. Shunt protection diodes are included to clip peak voltage excursions above approximately 15V to prevent voltage breakdown in worst case conditions.	

Application Schematic

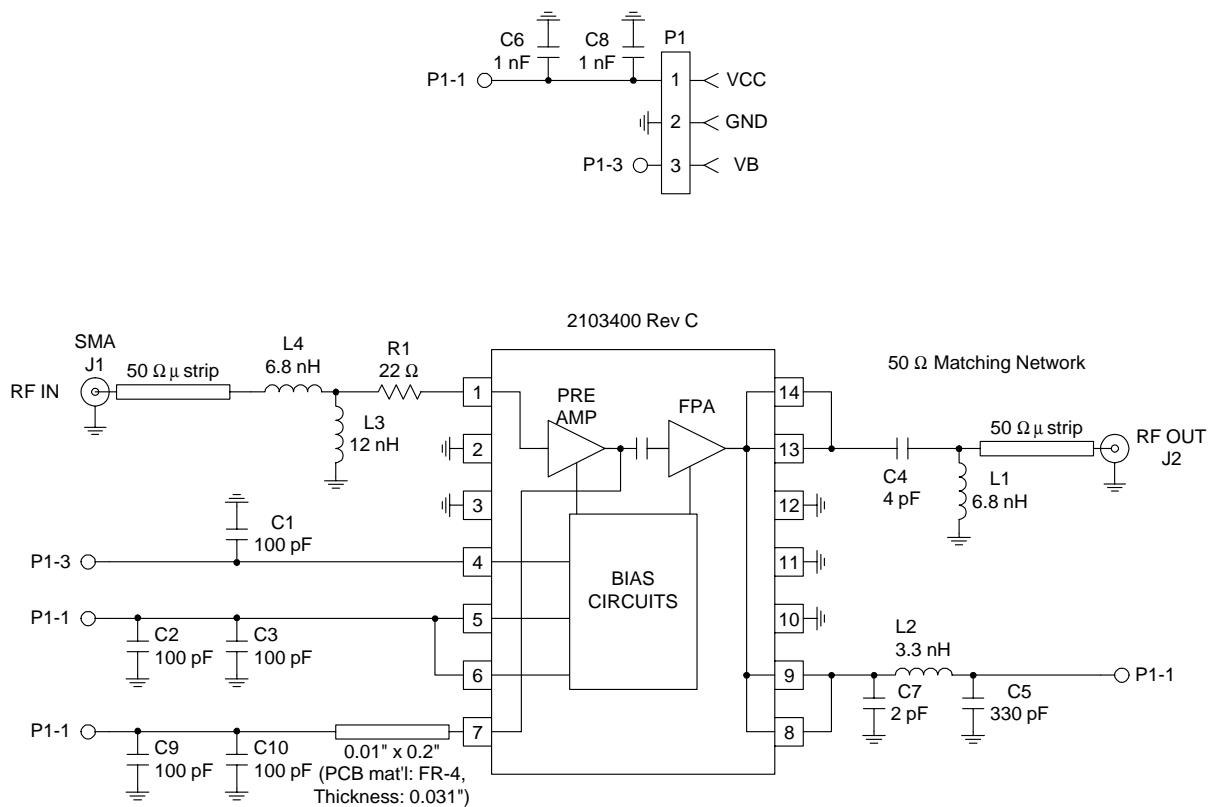


FREQUENCY (MHz)	L1 (nH)	L2 (nH)	L3 (nH)	L4 (nH)	C1 (pF)	C2 (pF)
275	20	15	10	20	20	10
480	12	6.8	4.7	18	12	6.8
915	6.8	3.3	—	—	4	2

Evaluation Board Schematic

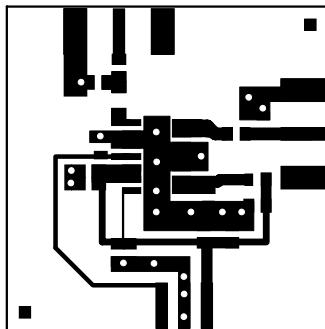
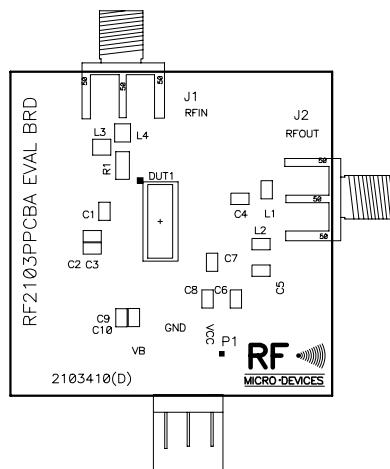
915MHz Operation

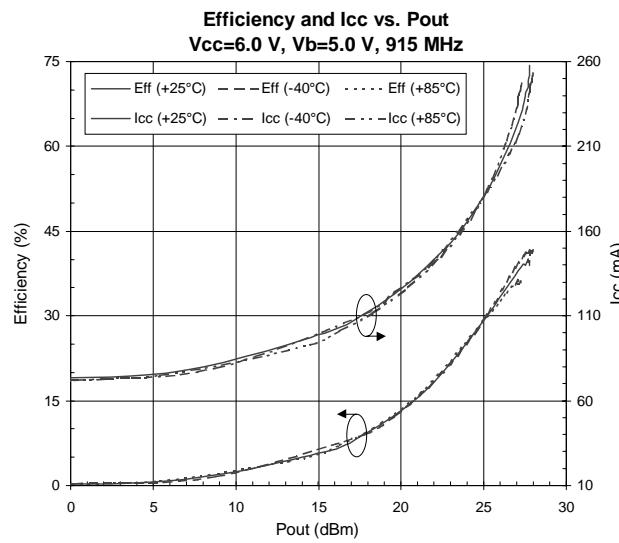
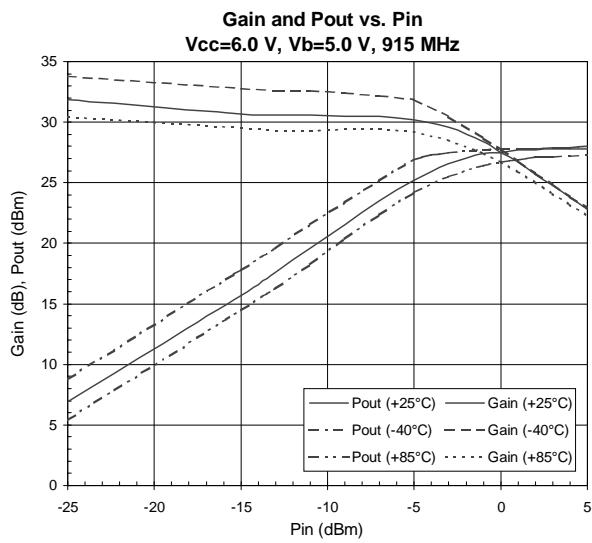
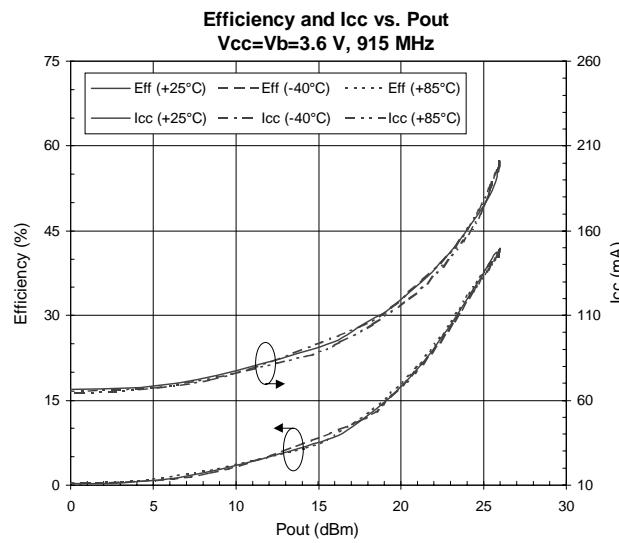
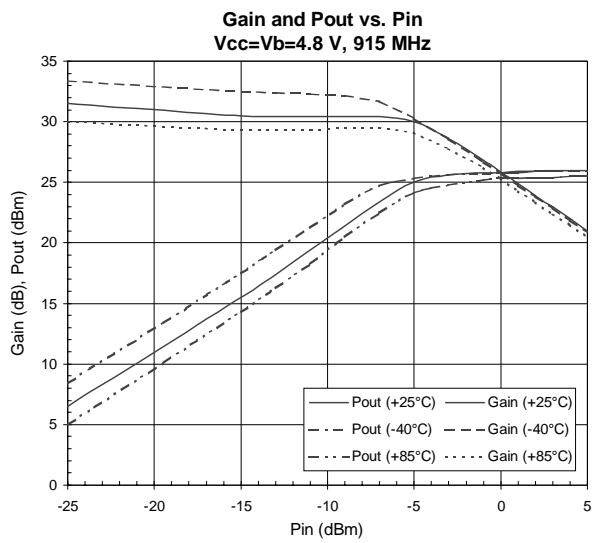
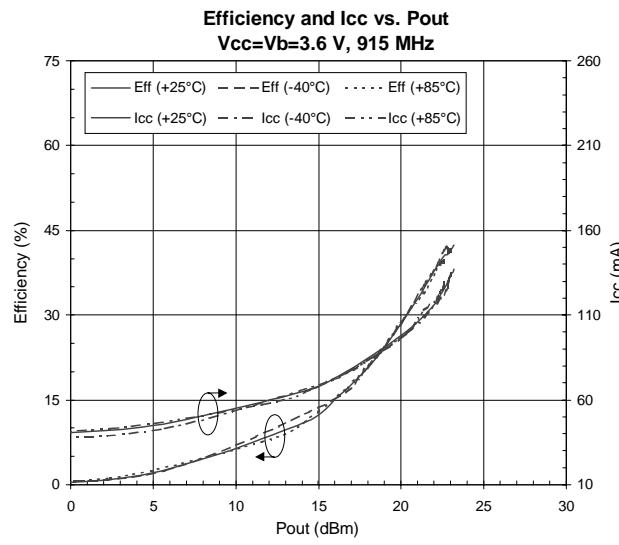
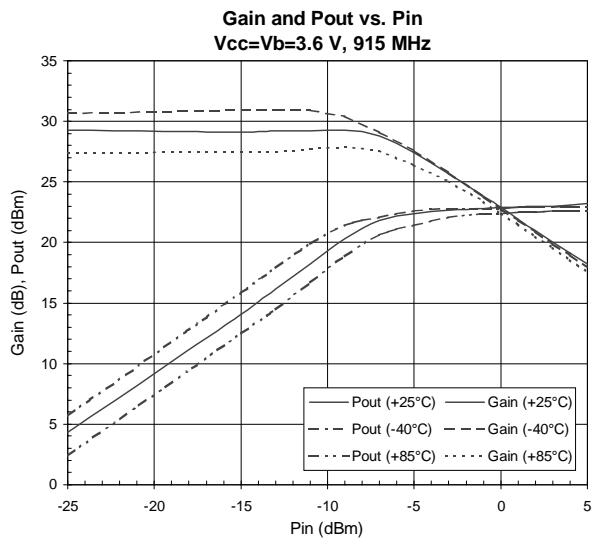
(Download [Bill of Materials](#) from www.rfmd.com.)



RF2103P

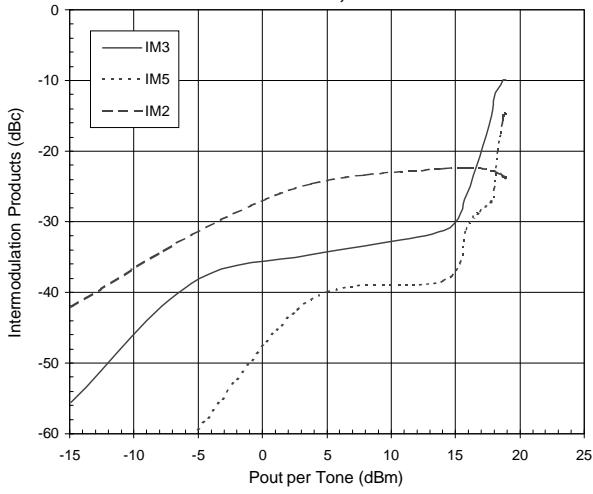
Evaluation Board Layout 1.4" x 1.4"



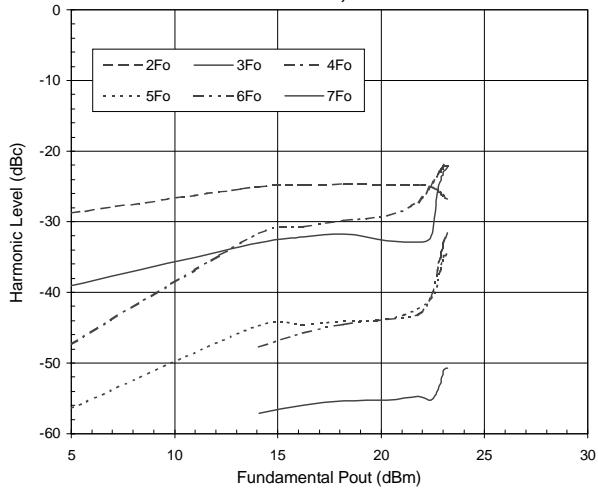


RF2103P

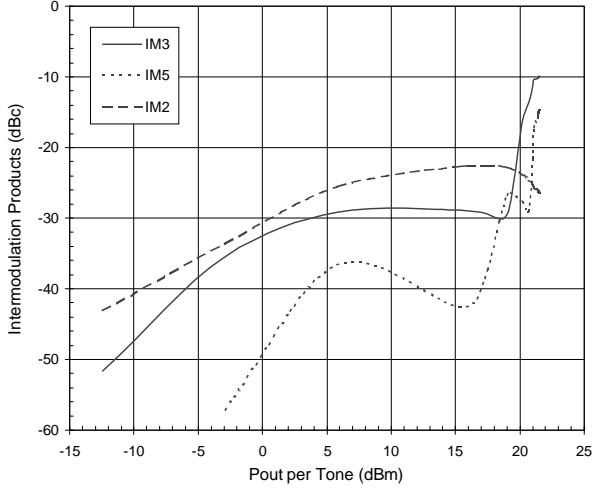
IM3, IM5, and IM2 vs. Pout
 $V_{cc}=V_b=3.6\text{ V}$, 915 MHz



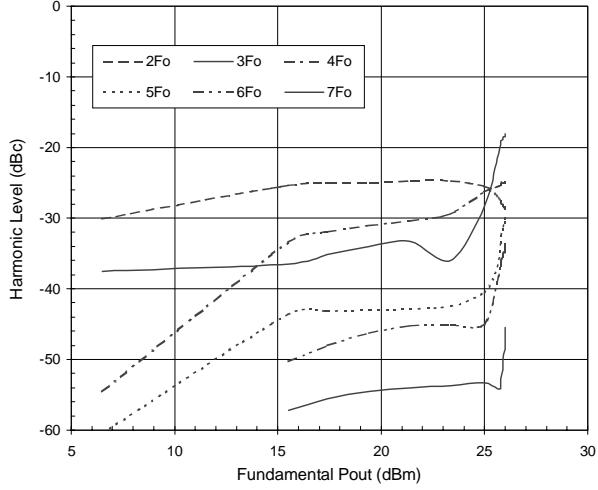
Harmonics vs. Pout
 $V_{cc}=V_b=3.6\text{ V}$, 915 MHz



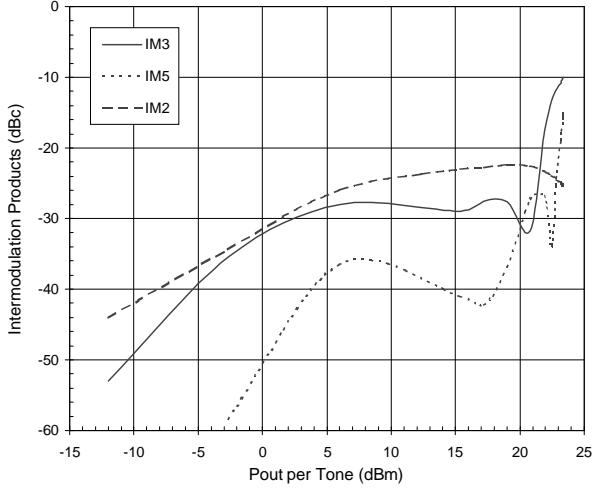
IM3, IM5, and IM2 vs. Pout
 $V_{cc}=V_b=4.8\text{ V}$, 915 MHz



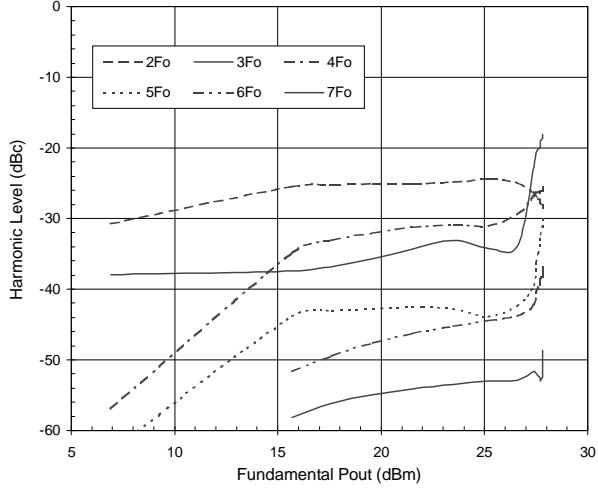
Harmonics vs. Pout
 $V_{cc}=V_b=4.8\text{ V}$, 915 MHz

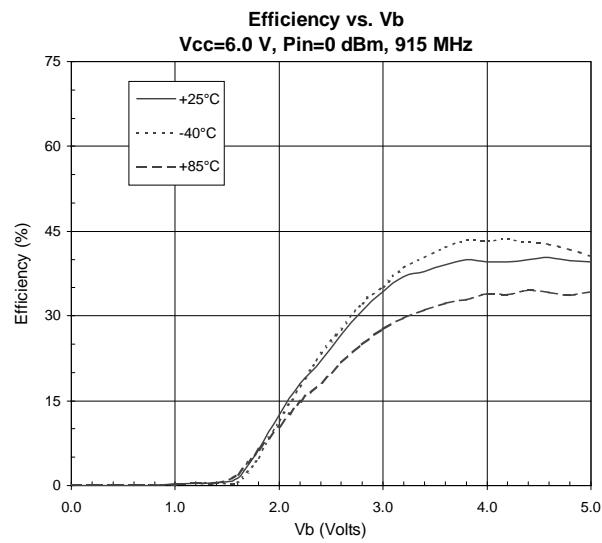
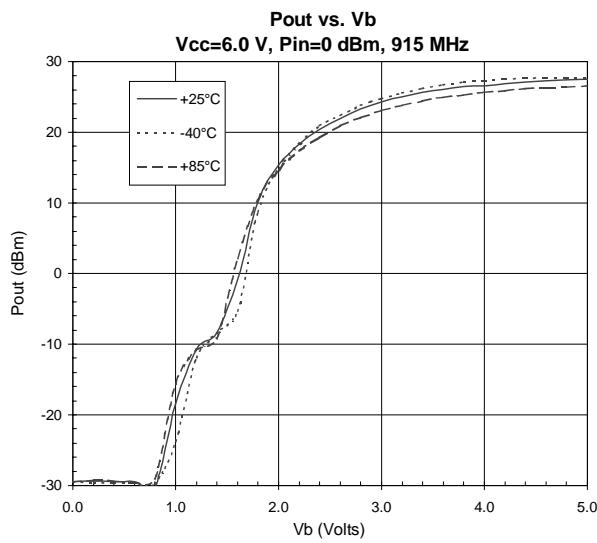
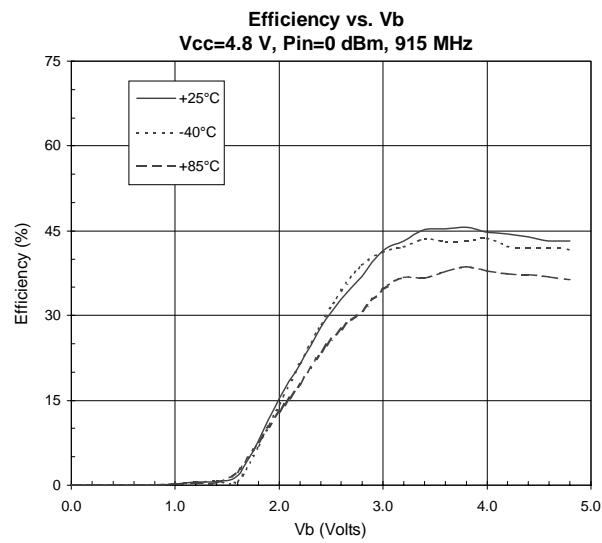
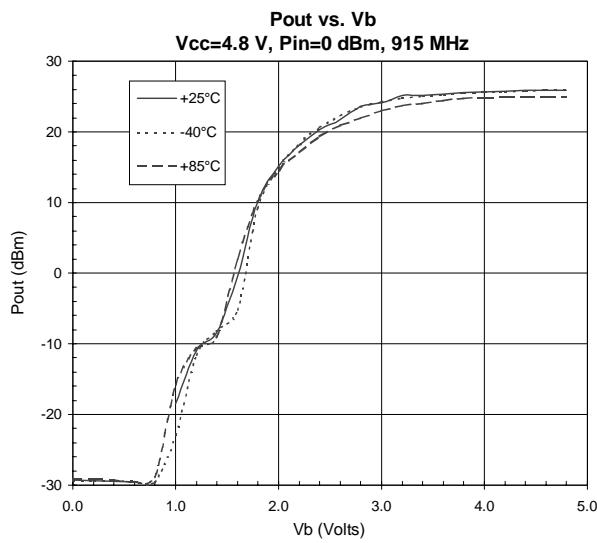
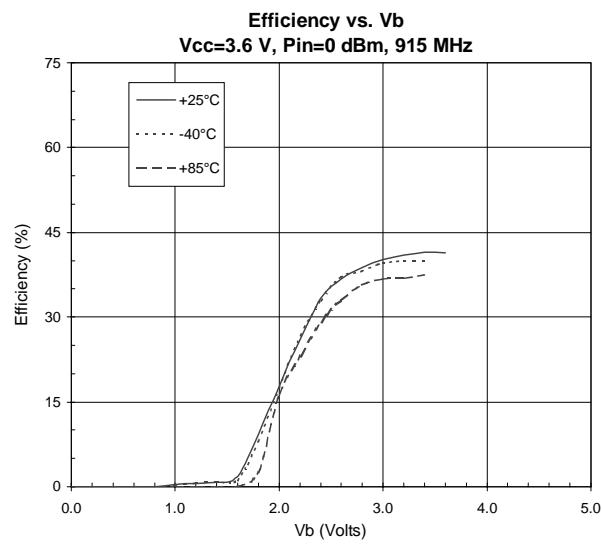
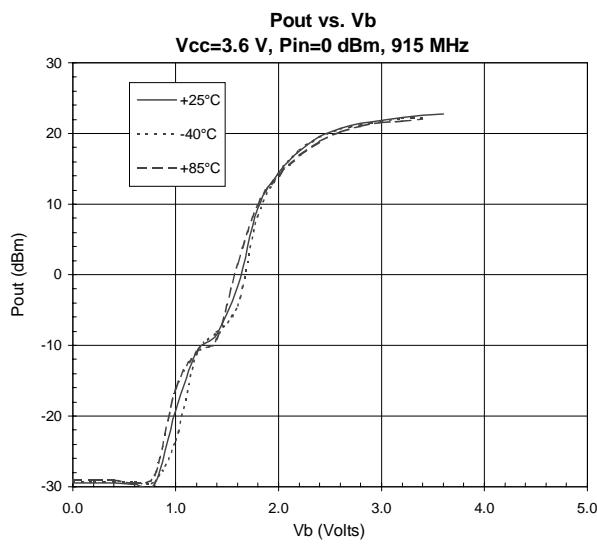


IM3, IM5, and IM2 vs. Pout
 $V_{cc}=6.0\text{ V}, V_b=5.0\text{ V}$, 915 MHz



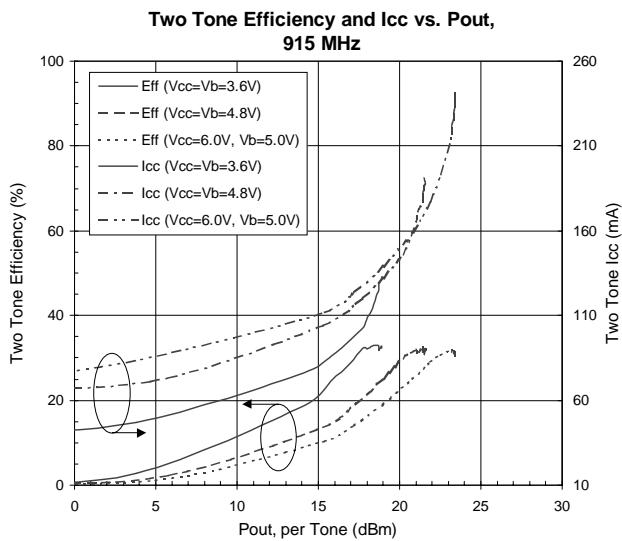
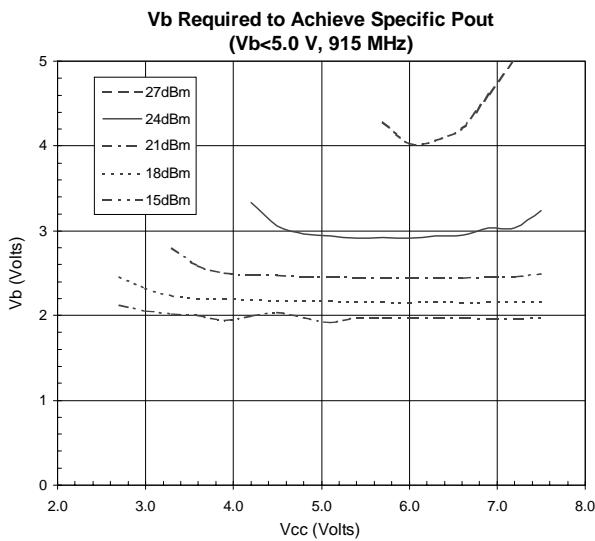
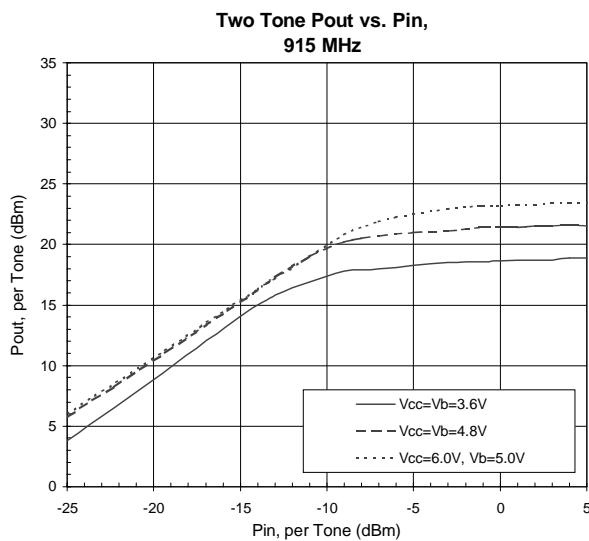
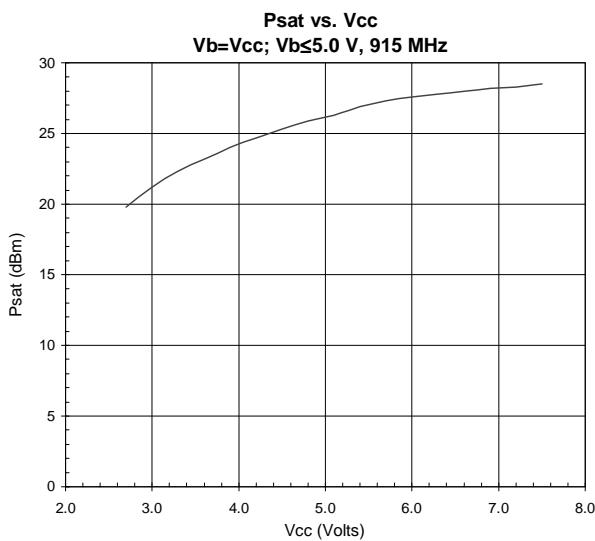
Harmonics vs. Pout
 $V_{cc}=6.0\text{ V}, V_b=5.0\text{ V}$, 915 MHz





RF2103P

2 POWER AMPLIFIERS



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详情浏览: <http://www.edatop.com/peixun/antenna/116.html>

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